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October 2014

FDMS5352

N-Channel Power Trench[®] MOSFET 60V, 49A, 6.7mΩ

Features

- Max $r_{DS(on)}$ = 6.7mΩ at V_{GS} = 10V, I_D = 13.6A
- Max $r_{DS(on)}$ = 8.2mΩ at V_{GS} = 4.5V, I_D = 12.3A
- Advanced Package and Silicon combination for low $r_{DS(on)}$
- MSL1 robust package design
- 100% UIL Tested
- RoHS Compliant

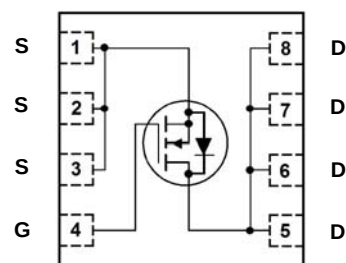
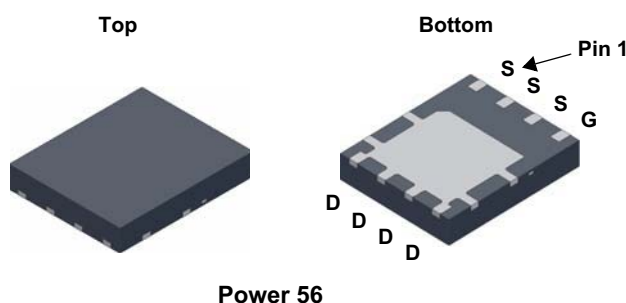


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

- DC - DC Conversion



MOSFET Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DS}	Drain to Source Voltage	60	V
V_{GS}	Gate to Source Voltage	± 20	V
I_D	Drain Current -Continuous (Package limited) $T_C = 25^\circ\text{C}$	49	A
	-Continuous (Silicon limited) $T_C = 25^\circ\text{C}$	88	
	-Continuous $T_A = 25^\circ\text{C}$ (Note 1a)	13.6	
	-Pulsed	100	
E_{AS}	Single Pulse Avalanche Energy (Note 3)	600	mJ
P_D	Power Dissipation $T_C = 25^\circ\text{C}$	104	W
	Power Dissipation $T_A = 25^\circ\text{C}$ (Note 1a)	2.5	
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ\text{C}$

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.2	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS5352	FDMS5352	Power 56	13"	12mm	3000 units

Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Off Characteristics

BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250\mu\text{A}$, $V_{GS} = 0\text{V}$	60			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu\text{A}$, referenced to 25°C		57		$\text{mV}/^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$, $V_{DS} = 48\text{V}$,			1	μA
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$			± 100	nA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250\mu\text{A}$	1.0	1.8	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250\mu\text{A}$, referenced to 25°C		-6.6		$\text{mV}/^\circ\text{C}$
$r_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = 10\text{V}$, $I_D = 13.6\text{A}$		5.6	6.7	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}$, $I_D = 12.3\text{A}$		6.7	8.2	
		$V_{GS} = 10\text{V}$, $I_D = 13.6\text{A}$, $T_J = 125^\circ\text{C}$		9.7	11.6	
g_{FS}	Forward Transconductance	$V_{DD} = 5\text{V}$, $I_D = 13.6\text{A}$		76		S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 30\text{V}$, $V_{GS} = 0\text{V}$, $f = 1\text{MHz}$		5220	6940	pF
C_{oss}	Output Capacitance			410	545	pF
C_{rss}	Reverse Transfer Capacitance			225	335	pF
R_g	Gate Resistance	$f = 1\text{MHz}$	0.1	1.3	2.6	Ω

Switching Characteristics

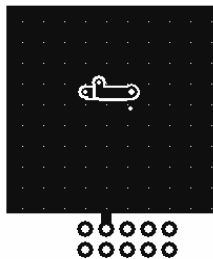
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 30\text{V}$, $I_D = 13.6\text{A}$, $V_{GS} = 10\text{V}$, $R_{GEN} = 6\Omega$		19	34	ns
t_r	Rise Time			11	21	ns
$t_{d(off)}$	Turn-Off Delay Time			58	93	ns
t_f	Fall Time			7	15	ns
Q_g	Total Gate Charge			93	131	nC
Q_g	Total Gate Charge	$V_{GS} = 0\text{V}$ to 5V	$V_{DD} = 30\text{V}$, $I_D = 13.6\text{A}$	48	67	nC
Q_{gs}	Gate to Source Charge	$V_{GS} = 0\text{V}$ to 10V		14		nC
Q_{gd}	Gate to Drain "Miller" Charge	$V_{GS} = 0\text{V}$ to 5V		17		nC

Drain-Source Diode Characteristics

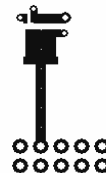
V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0\text{V}$, $I_S = 13.6\text{A}$ (Note 2)		0.8	1.3	V
		$V_{GS} = 0\text{V}$, $I_S = 2.1\text{A}$ (Note 2)		0.7	1.2	
t_{rr}	Reverse Recovery Time	$I_F = 13.6\text{A}$, $di/dt = 100\text{A}/\mu\text{s}$		39	63	ns
Q_{rr}	Reverse Recovery Charge			48	77	nC

NOTES:

1. $R_{\theta JA}$ is determined with the device mounted on a 1in^2 pad 2 oz copper pad on a $1.5 \times 1.5\text{in.}$ board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a. $50^\circ\text{C}/\text{W}$ when mounted on a 1in^2 pad of 2 oz copper.



b. $125^\circ\text{C}/\text{W}$ when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width $< 300\mu\text{s}$, Duty cycle $< 2.0\%$.

3. Starting $T_J = 25^\circ\text{C}$, $L = 3\text{mH}$, $I_{AS} = 20\text{A}$, $V_{DD} = 60\text{V}$, $V_{GS} = 10\text{V}$

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

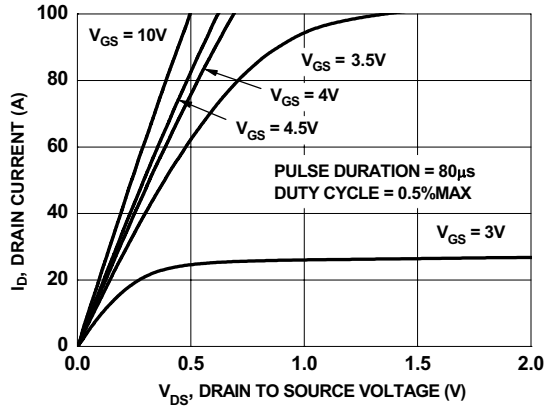


Figure 1. On-Region Characteristics

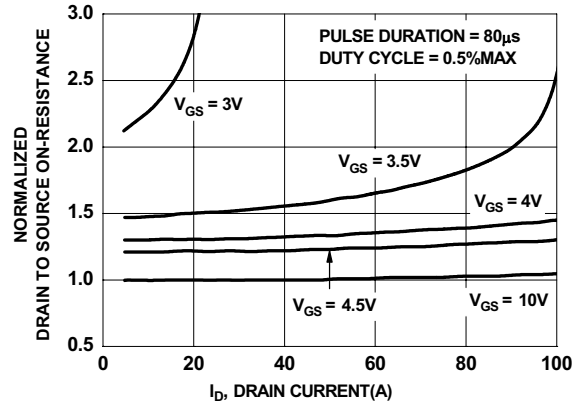


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

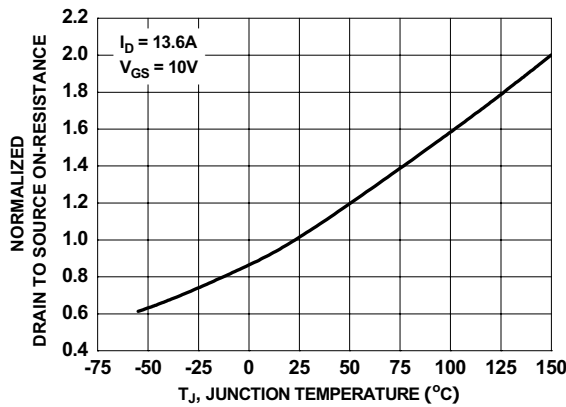


Figure 3. Normalized On-Resistance vs Junction Temperature

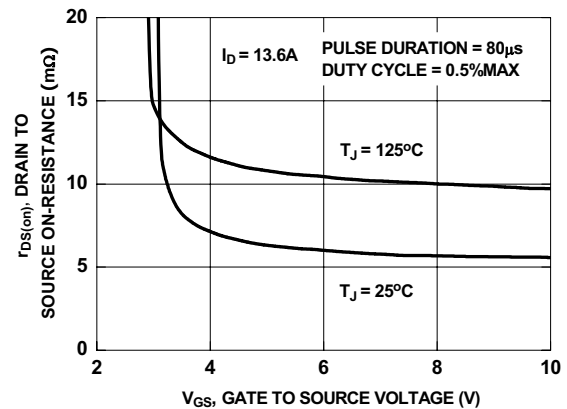


Figure 4. On-Resistance vs Gate to Source Voltage

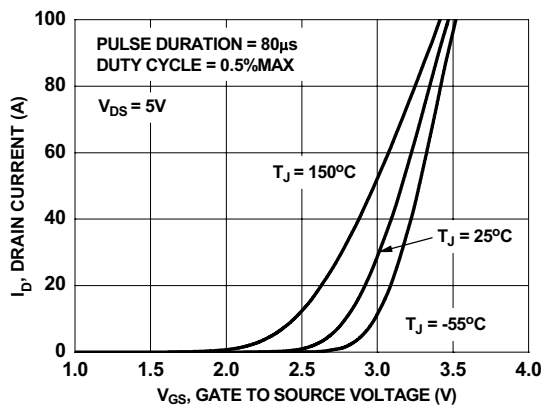


Figure 5. Transfer Characteristics

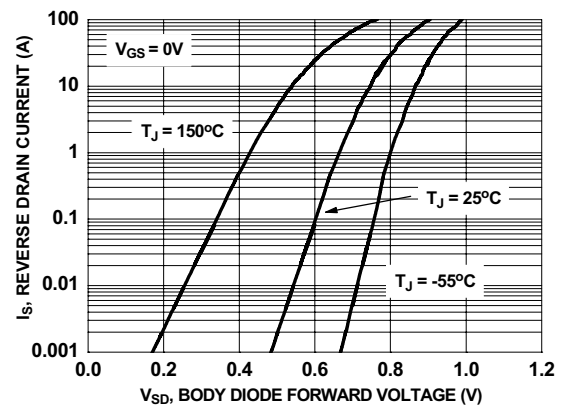


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

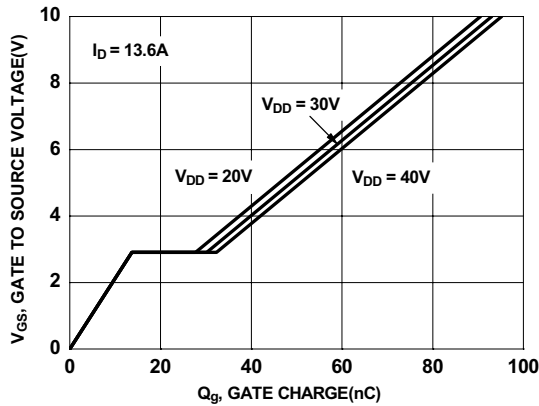


Figure 7. Gate Charge Characteristics

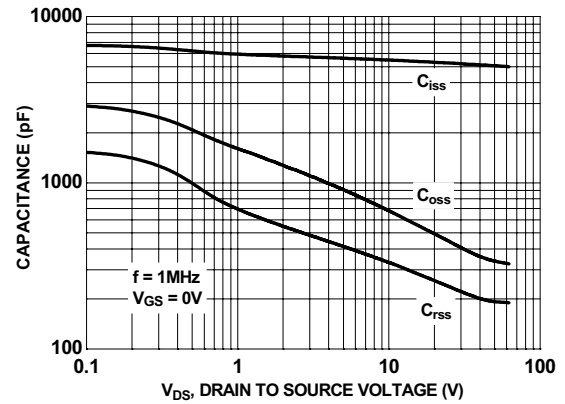


Figure 8. Capacitance vs Drain to Source Voltage

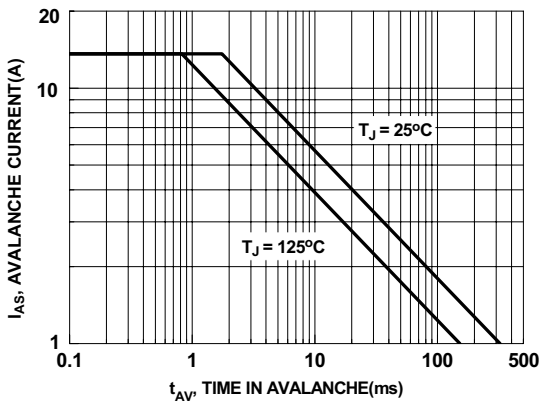


Figure 9. Unclamped Inductive Switching Capability

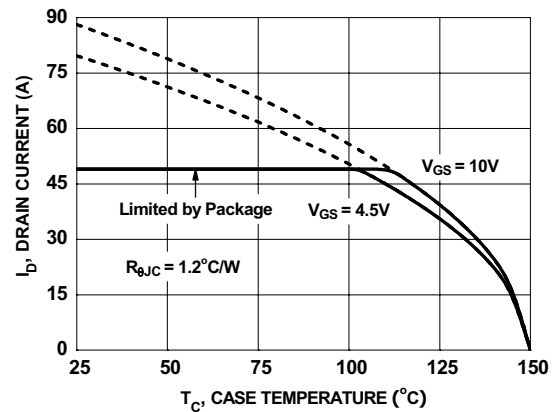


Figure 10. Maximum Continuous Drain Current vs Case Temperature

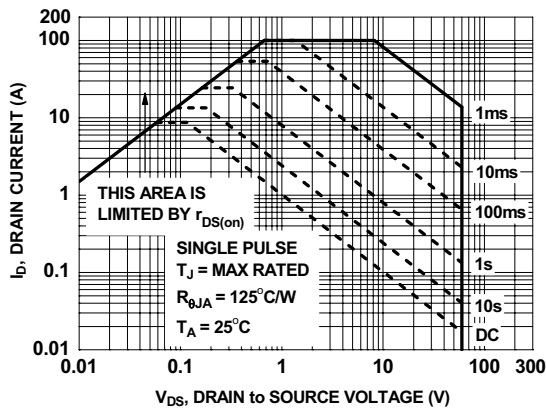


Figure 11. Forward Bias Safe Operating Area

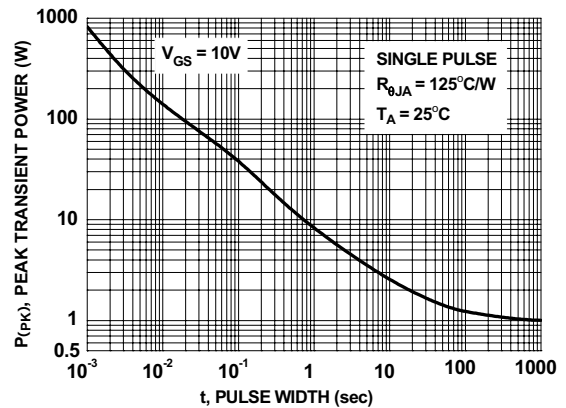
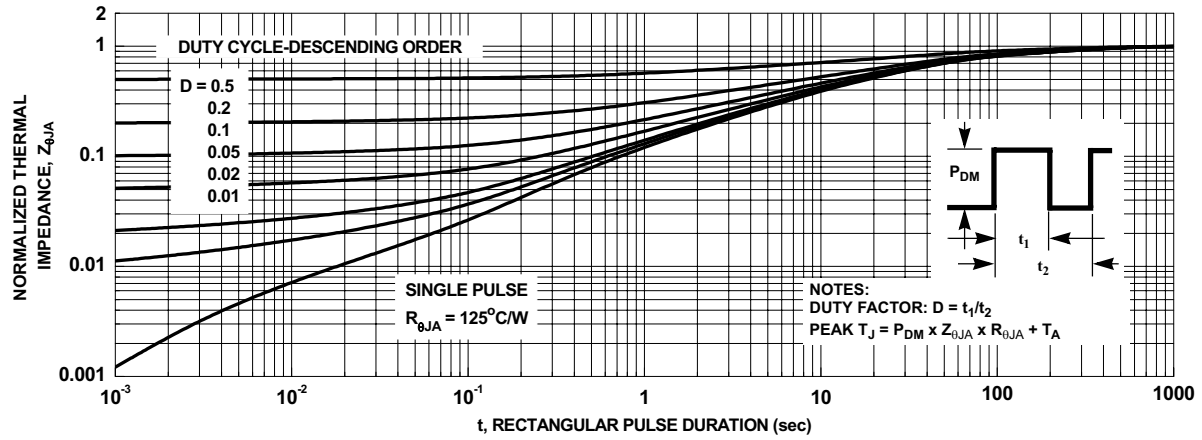
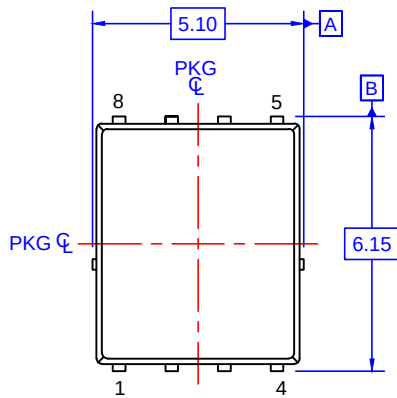


Figure 12. Single Pulse Maximum Power Dissipation

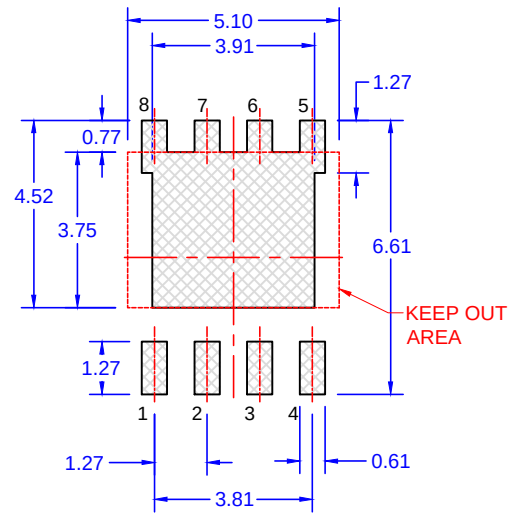
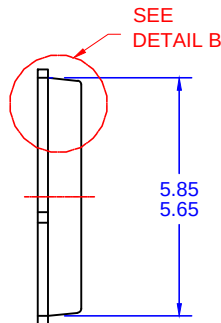
Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted



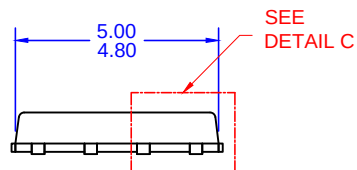
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CASE 483AE
ISSUE A



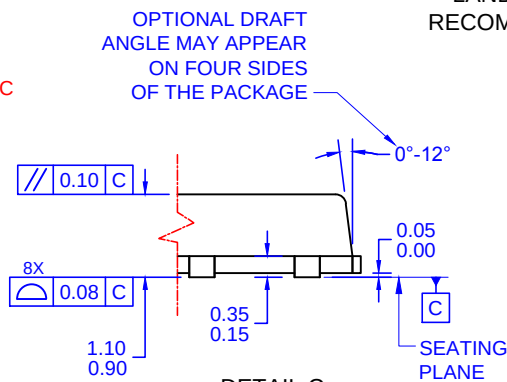
TOP VIEW



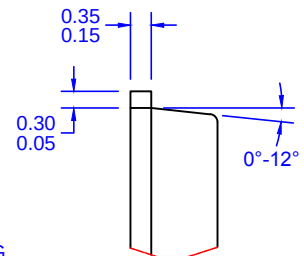
LAND PATTERN
RECOMMENDATION



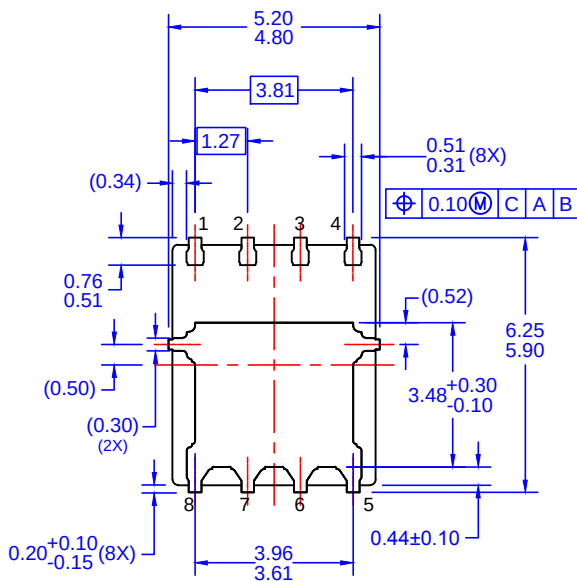
SIDE VIEW



DETAIL C
SCALE: 2:1



DETAIL B
SCALE: 2:1



BOTTOM VIEW

NOTES: UNLESS OTHERWISE SPECIFIED

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- ALL DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
- IT IS RECOMMENDED TO HAVE NO TRACES OR VIAS WITHIN THE KEEP OUT AREA.

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Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

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